



ZHCS500

SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _R (V)	I _F (mA)	V _{F(MAX)} (mV)	I _{R(MAX)} (μA)
40	500	550	40

Applications

- DC DC Converters
- Mobile Telecomms
- PCMIA

Features

- High Current Capability (I_F = 500mA)
- Low V_F
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)





Top View



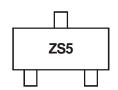
Ordering Information (Note 5)

Part Number	Case	Packaging
ZHCS500TA	SOT23	3000/Tape & Reel
ZHCS500QTA	SOT23	3000/Tape & Reel
ZHCS500QTC	SOT23	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



ZS5 = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Continuous Reverse Voltage		V_R	40	V
Continuous Forward Current		l _F	500	mA
Forward Voltage @ I _F = 500mA		V_{F}	550	mV
Average Peak Forward Current; D.C. = 50%		I _{FAV}	1000	mA
Non Repetitive Forward Current	t ≤ 100µs	_	6.75	Α
	t ≤ 10ms	IFSM	3	Α

Thermal Characteristics

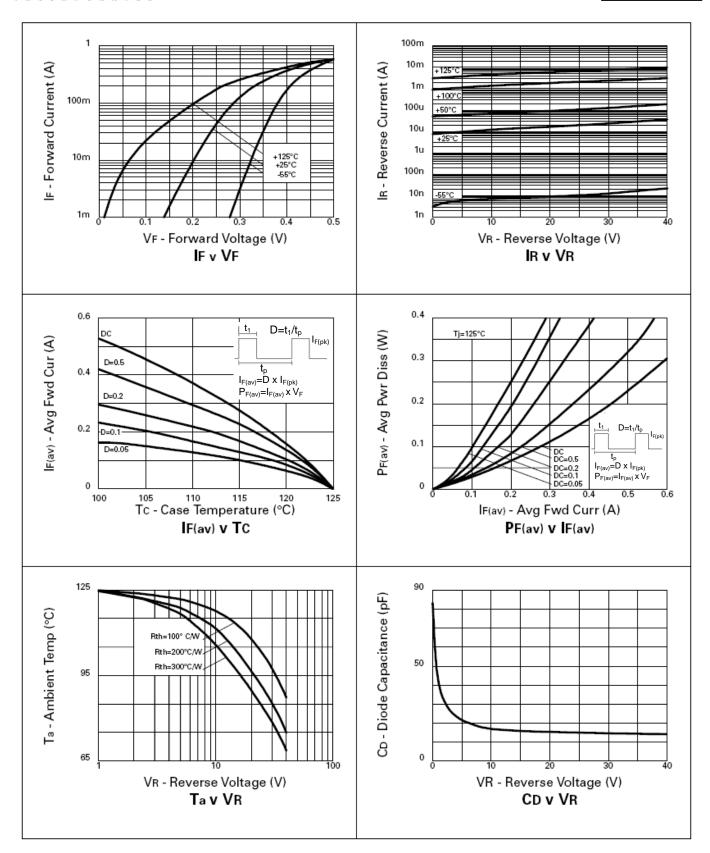
Characteristic	Symbol	Value	Unit
Power Dissipation, T _A = +25°C	P_{D}	330	mW
Junction Temperature	TJ	125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

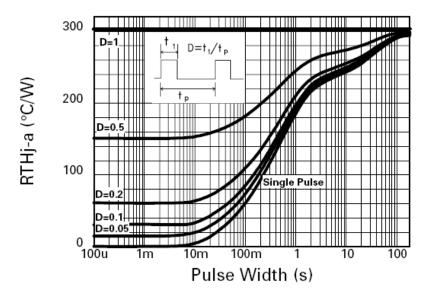
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	40	60	_	V	I _R = 200μA
		_	270	300	mV	I _F = 50mA
		_	300	350		I _F = 100mA
		_	370	460		$I_F = 250 \text{mA}$
Forward Voltage (Note 6)	.,	_	465	550		I _F = 500mA
Polward Voltage (Note 6)	VF	_	550	670	IIIV	$I_F = 750 \text{mA}$
		_	640	780		I _F = 1A
		_	810	1050		I _F = 1.5A
		_	440	_		$I_F = 500 \text{mA}, T_A = +100 ^{\circ}\text{C}$
Reverse Current	I _R	_	15	40	μΑ	V _R = 30V
Diode Capacitance	C _D	_	20	_	pF	$f = 1MHz, V_R = 25V$
		_			ns	Switched from I _F = 500mA to
Reverse Recovery Time	t _{RR}		10	_		I _R = 500mA
						Measured @ I _R = 50mA

Notes: 6. Measured under pulsed conditions. Pulse width = 300μ S. Duty cycle = 2%.





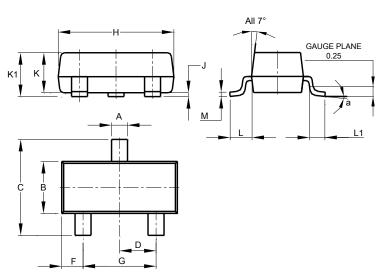




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



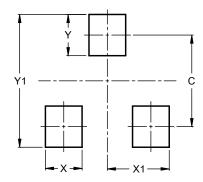
SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)		
С	2.0		
Х	0.8		
X1	1.35		
Y	0.9		
Y1	2.9		

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